First Name: Fare clic o toccare qui per immettere il testo.

Last Name: Fare clic o toccare qui per immettere il testo.

Institution/Company: Fare clic o toccare qui per immettere il testo.

e-Mail: Fare clic o toccare qui per immettere il testo.

**ACCEPTED PAPER submission number (if applicable)**: Fare clic o toccare qui per immettere il testo.

Registration ID: Fare clic o toccare qui per immettere il testo.

Passport No: Fare clic o toccare qui per immettere il testo.

Date of Issue: Fare clic o toccare qui per immettere il testo.

Date of Expiry: Fare clic o toccare qui per immettere il testo.

Dear Fare clic o toccare qui per immettere il testo.,

on behalf of the Organizing Committee, I cordially invite you to participate in the forthcoming **ESREF 2024**, 35th European Symposium on Reliability of Electron Devices, Failure Physics and Analysis, which will be held in Parma (ITALY) on 23 -26 September, 2024

Indeed, your participation would certainly enrich the Congress and contribute to its success therefore feel free to use this letter for Visa purpose.

I take this opportunity to clarify that this letter does not constitute any financial obligation on behalf of the Organizers. Any travel, subsistence, health insurance, conference fees, and any other expenses will be entirely your responsibility.

Looking forward to seeing you in Parma, we send kindest regards.

Prof. PAOLO COVA

University of Parma (IT)

Co*nference Chair*